

INTRODUCTION

SN67d10 Series is a 10 seconds one-channel single chip voice synthesizer IC which contains a PWM Direct Drive Circuit. There are two IO pins (one input, one IO), which can be configured as two trigger pins, or one trigger and one output. By filling a coding form, users' applications, including section combination, trigger modes, and different output status, can be easily implemented.

■ FEATURES

- Single power supply 2.4V 5.1V
- 10 seconds voice capacity is provided
- 1-bit input port (P1) and 1-bit I/O port (P2) are provided
- 16*1 bits RAM are provided
- Built in a high quality speech synthesizer
- Two different playing rate, 6KHz and 8KHz.
- Built in a PWM Direct Drive circuit output BUO1 and BUO2 directly connected to Speaker for sound output
- System clock: 2MHZ
- Low Voltage Reset

■ PIN ASSIGNMENT

Symbol	I/O	Function Description
P1	I	Input port
P2	I/O	I/O port
VDD	I	Positive power supply
OSC	I	Oscillation component connection pin
GND	I	Negative power supply
BUO1	0	PWM output 1
BUO2	0	PWM output 2

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■ ABSOLUTE MAXIMUM RATINGS

Items	Symbol	Min	Max	Unit.
Supply Voltage	V _{DD} -V	-0.3	6.0	V
Input Voltage	V_{IN}	GND-0.3	V _{DD} +0.3	V
Operating Temperature	T _{OP}	-20.0	70.0	°C
Storage Temperature	T _{STG}	-55.0	125.0	°C

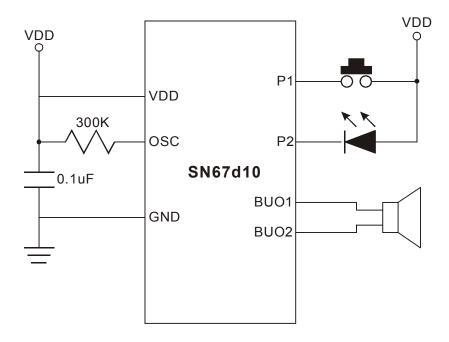
■ ELECTRICAL CHARACTERISTICS

Item	Sym.	Min.	Тур.	Max.	Unit	Condition
Operating Voltage	V_{DD}	2.4	3.0	5.1	٧	
Standby current	I _{SBY}	ı	-	2.0	иA	V _{DD} =3V, no load
Operating Current	I _{OPR}	ı	-	250	иA	V _{DD} =3V, no load
Input current of P1, P2	I _{IH}	1	3.0	10.0	иA	V_{DD} =3 V , V_{IN} =3 V
Drive current of P2	I _{OD}	1.5	2	-	mΑ	V_{DD} =3 V , V_{O} =2.4 V
Sink Current of P2	Ios	2.0	3	-	mΑ	$V_{DD} = 3V, V_{O} = 0.4V$
Drive current of Buo1	I _{OD}	100	120	-	mΑ	VDD=3V,Buo1=1.5V
Sink Current of Buo1	Ios	100	120	-	mΑ	VDD=3V,Buo1=1.5V
Drive Current of Buo2	I _{OD}	100	120	-	mΑ	VDD=3V,Buo2=1.5V
Sink Current of Buo2	Ios	100	120	-	mΑ	VDD=3V,Buo2=1.5V
Oscillation Freq.	Fosc		2.0	-	MHz	V _{DD} =3V

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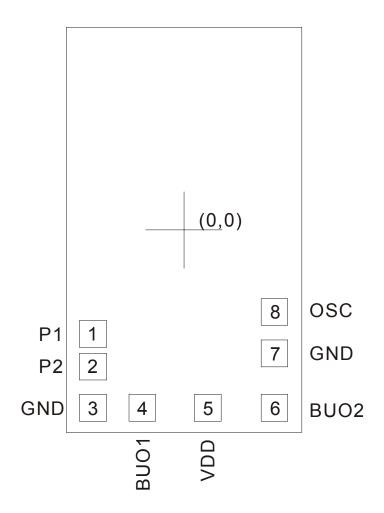
■ APPLICATION CIRCUIT



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BONDING PAD



Note: The substrate MUST be connected to Vss in PCB layout.

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